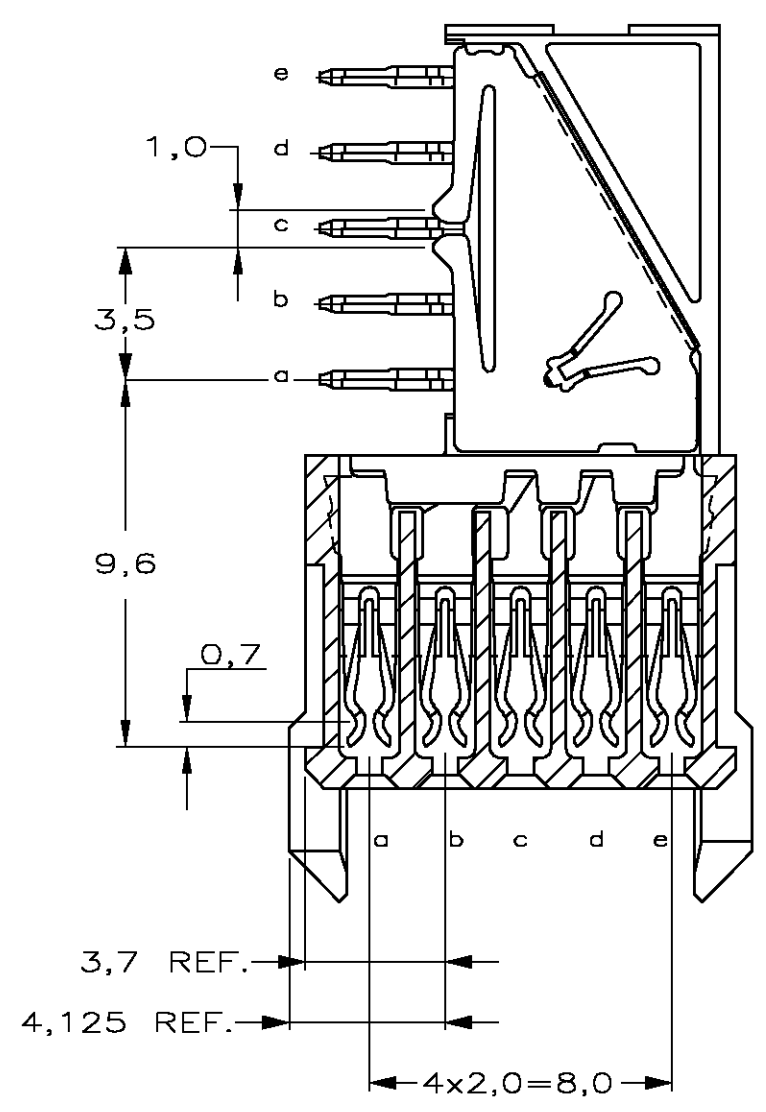


DO NOT SCALE
DIMENSIONS IN mm

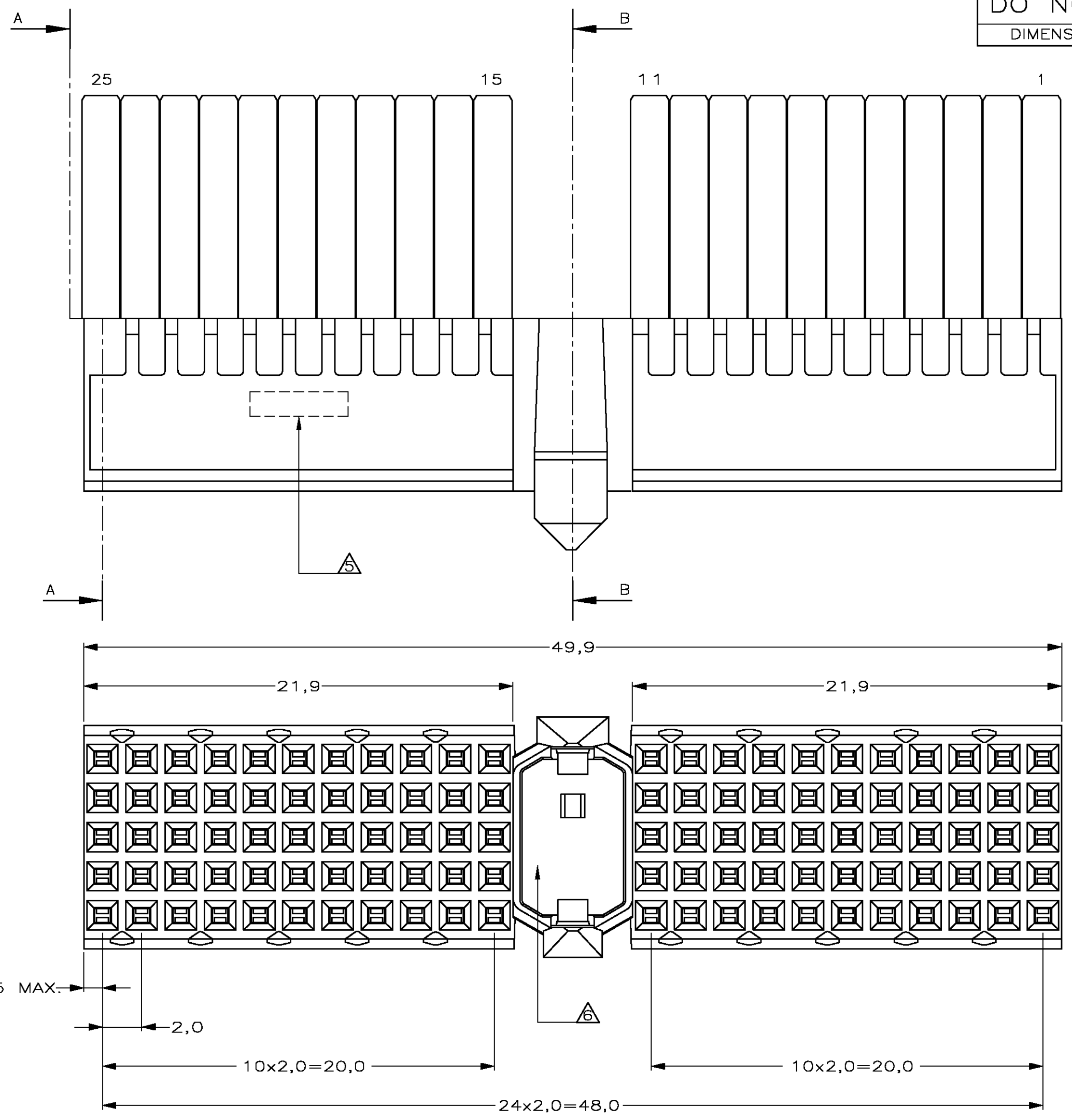
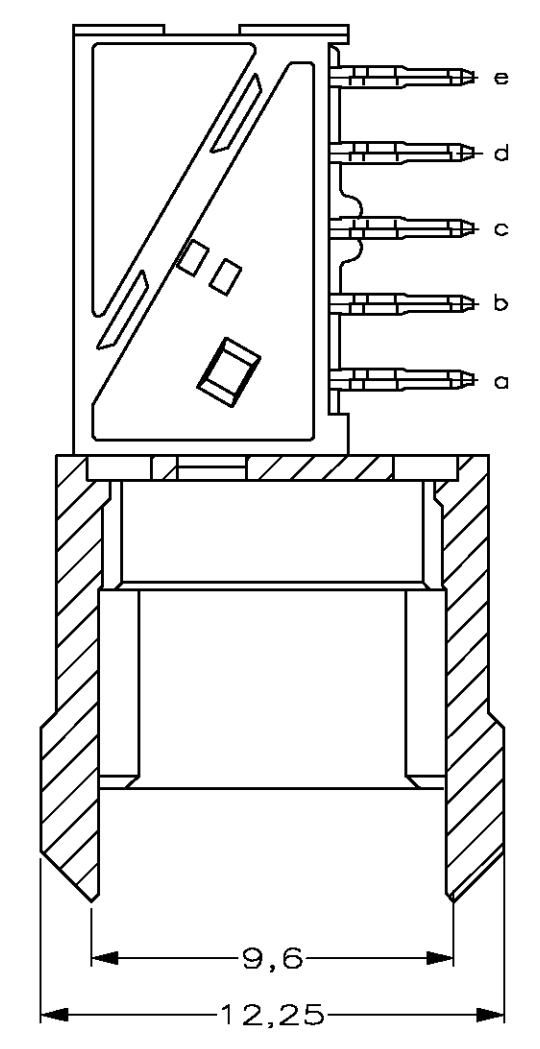
METRIC

THIRD ANGLE
PROJECTION

SECTION A-A



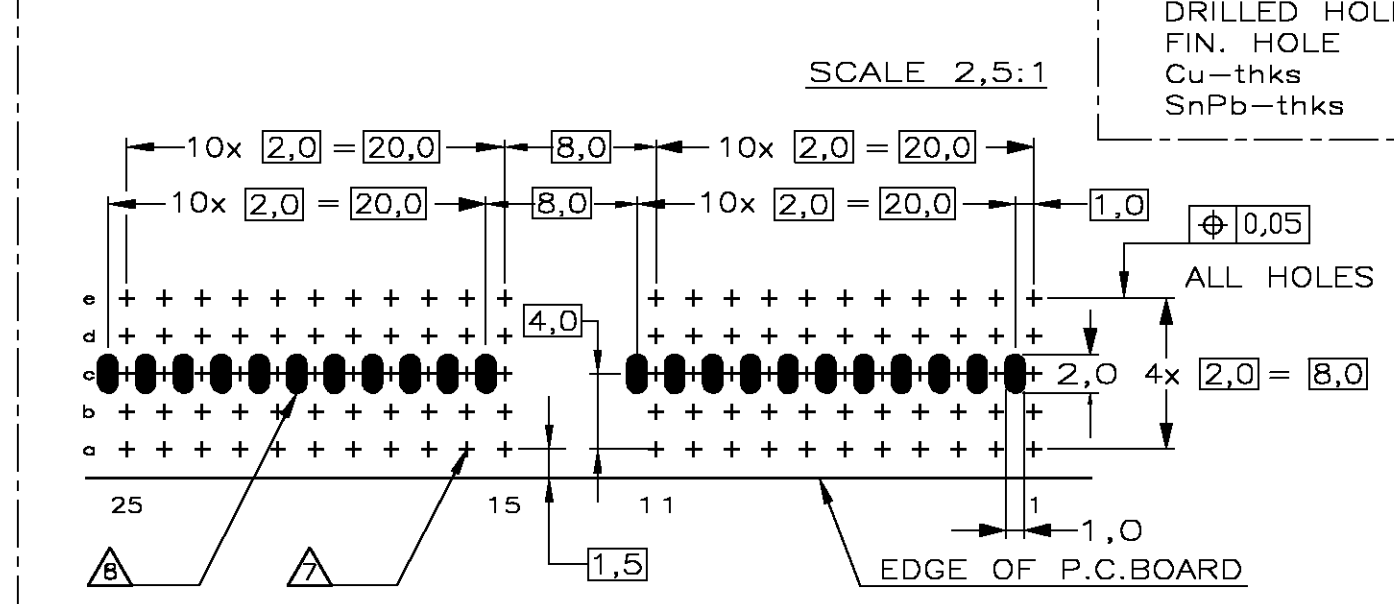
SECTION B-B



NOTES:

- △ PLATING CONTACT AREA: 0,76µm Au MIN. OVER 1,27µm Ni MIN
ACTION PIN, 0,5µm SnPb MIN. OVER 1,27µm Ni MIN
REDUCED CROSS-TALK SHIELD, 0,5µm SnPb MIN.
- △ PLATING CONTACT AREA: 2,0µm Au MIN. OVER 1,27µm Ni MIN
ACTION PIN, 0,5µm SnPb MIN. OVER 1,27µm Ni MIN
REDUCED CROSS-TALK SHIELD, 0,5µm SnPb MIN.
- △ PLATING CONTACT AREA: 1,27µm Au MIN. OVER 1,27µm Ni MIN
ACTION PIN, 0,5µm SnPb MIN. OVER 1,27µm Ni MIN
REDUCED CROSS-TALK SHIELD, 0,5µm SnPb MIN.
- △ MATERIAL :
CONTACT; PHOSPHORBRONZE
REDUCED CROSS-TALK SHIELD; PHOSPHORBRONZE
HOUSING; GLASSFILLED POLYESTER (GRAY)
- △ CONNECTOR PRINTED WITH PARTNUMBER AND DATECODE
THE MARKING CAN APPEAR ON THE FRONT SIDE OR ON THE BACK SIDE.
- △ AREA RESERVED FOR KEYING PART (BASIC P.N.100526)
- △ PLATED-THROUGH HOLES AT 2x2mm SQUARE GRID
TOTAL 110 HOLES.
- △ PLATED SPOT ONLY ON COMPONENT SIDE, FORMING ONE CONTACT
WITH PLATED THROUGH HOLES OF ROW C
- 9 FITS ONLY WITH INTEGRATED GROUND RETURN
UPPERSHIELD 338107-2 AND LOWERSHIELD 338108-2.

RECOMMENDED P.C.B. HOLE LAY-OUT
COMPONENT SIDE AS SHOWN



P.C.B. HOLE DIM. ACTION PIN			
DRILLED HOLE	0,7	±0,025	mm
FIN. HOLE	0,55	TO 0,65	mm
Cu-thks	0,025	TO 0,050	mm
SnPb-thks	0,004	TO 0,010	mm

FINISH		MATERIAL		PARTNUMBER	
3		4		100623-4	
2		4		100623-3	
1		4		100623-1	
CUSTOMER DRAWING				FOR REFERENCE ONLY WILL NOT BE UPDATED	
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THIS DRAWING IS UNPUBLISHED RELEASED FOR PUBLICATION				19	
Tyco Electronics				Tyco Electronics Corp. Oostkamp, Belgium.	
NAME				Z-PACK 2mm H.M. TYPE A 110 POS. FEMALE CONNECTOR WITH REDUCED CROSS-TALK SHIELD	
DR.: E. MEHLMANN		CHK.: W.v.d. HEIJDEN		APP.: B. MOOIJ	
DATE: 11-FEB-97		DATE: 11-FEB-97		DATE: -	
DWG.No.		REV.LTR.		SHEET	
C-100623		H		1 OF 1	
				A2	